

General Purpose Transistors

NPN Silicon

L2N3904

MAXIMUM RATINGS

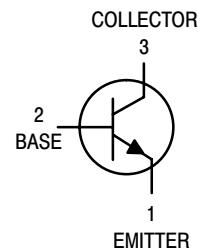
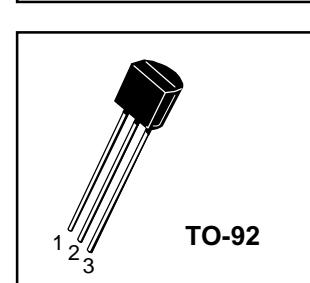
Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V_{CEO}	40	Vdc
Collector-Base Voltage	V_{CBO}	60	Vdc
Emitter-Base Voltage	V_{EBO}	6.0	Vdc
Collector Current - Continuous	I_C	200	mAdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	625 5.0	mW mW/ $^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	1.5 12	W mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-55 to +150	$^\circ\text{C}$

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

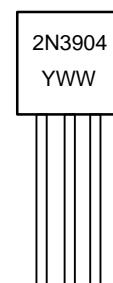
THERMAL CHARACTERISTICS (Note 1)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	200	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	83.3	$^\circ\text{C/W}$

1. Indicates Data in addition to JEDEC Requirements.

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MARKING DIAGRAM



Y = Year
WW = Work Week

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ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector-Emitter Breakdown Voltage (<i>I_C</i> = 1.0 mAdc, <i>I_B</i> = 0)	V _{(BR)CEO}	40	—	Vdc
Collector-Base Breakdown Voltage (<i>I_C</i> = 10 μ Adc, <i>I_E</i> = 0)	V _{(BR)CBO}	60	—	Vdc
Emitter-Base Breakdown Voltage (<i>I_E</i> = 10 μ Adc, <i>I_C</i> = 0)	V _{(BR)EBO}	6.0	—	Vdc
Base Cutoff Current (<i>V_{CE}</i> = 30 Vdc, <i>V_{EB}</i> = 3.0 Vdc)	I _{BL}	—	50	nAdc
Collector Cutoff Current (<i>V_{CE}</i> = 30 Vdc, <i>V_{EB}</i> = 3.0 Vdc)	I _{CEX}	—	50	nAdc

ON CHARACTERISTICS

DC Current Gain (Note 2) (<i>I_C</i> = 0.1 mAdc, <i>V_{CE}</i> = 1.0 Vdc) (<i>I_C</i> = 1.0 mAdc, <i>V_{CE}</i> = 1.0 Vdc) (<i>I_C</i> = 10 mAdc, <i>V_{CE}</i> = 1.0 Vdc) (<i>I_C</i> = 50 mAdc, <i>V_{CE}</i> = 1.0 Vdc) (<i>I_C</i> = 100 mAdc, <i>V_{CE}</i> = 1.0 Vdc)	<i>h_{FE}</i>	40	—	—
		70	—	
		100	300	
		60	—	
		30	—	
Collector-Emitter Saturation Voltage (Note 2) (<i>I_C</i> = 10 mAdc, <i>I_B</i> = 1.0 mAdc) (<i>I_C</i> = 50 mAdc, <i>I_B</i> = 5.0 mAdc)	V _{CE(sat)}	—	0.2 0.3	Vdc
Base-Emitter Saturation Voltage (Note 2) (<i>I_C</i> = 10 mAdc, <i>I_B</i> = 1.0 mAdc) (<i>I_C</i> = 50 mAdc, <i>I_B</i> = 5.0 mAdc)	V _{BE(sat)}	0.65 —	0.85 0.95	Vdc

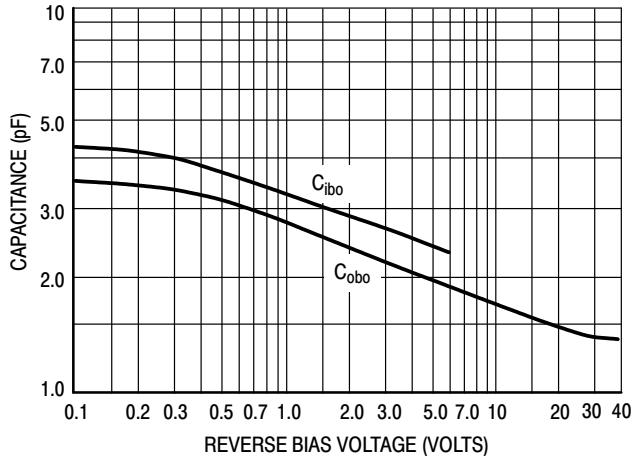
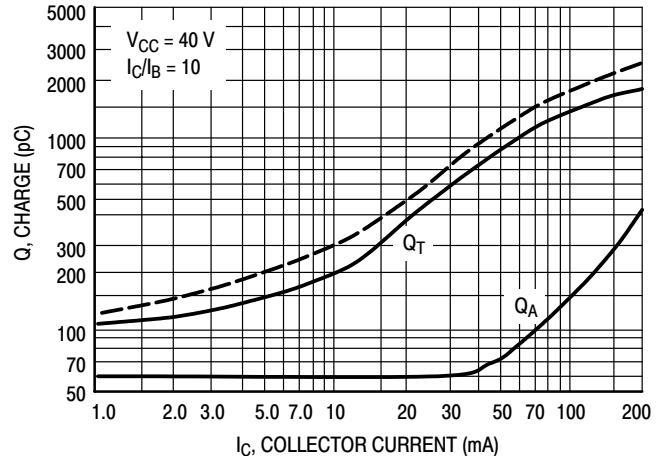
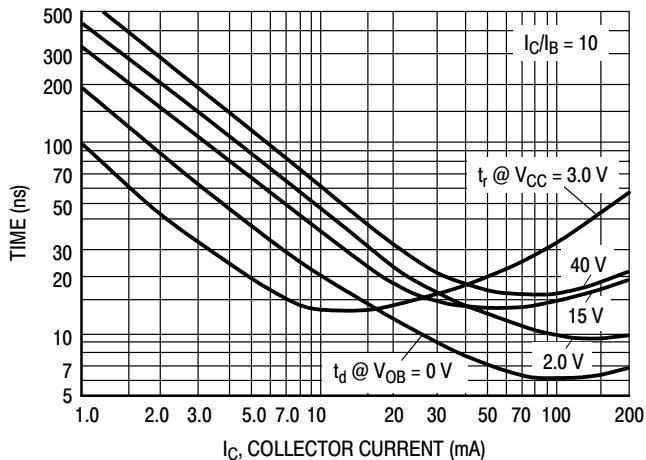
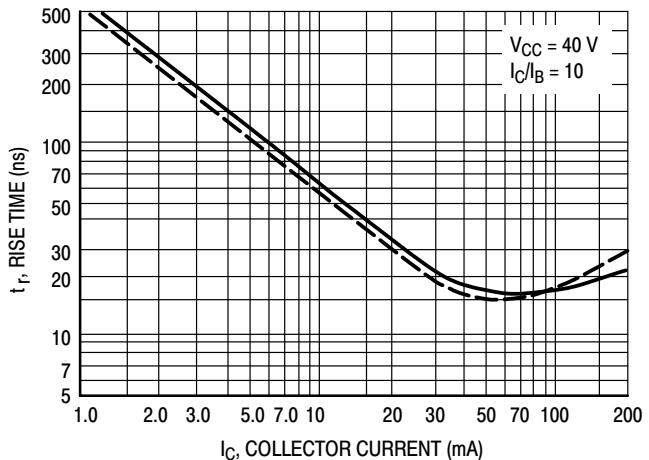
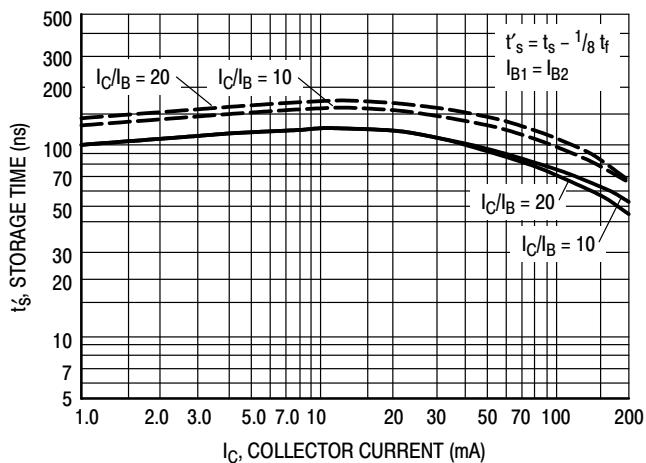
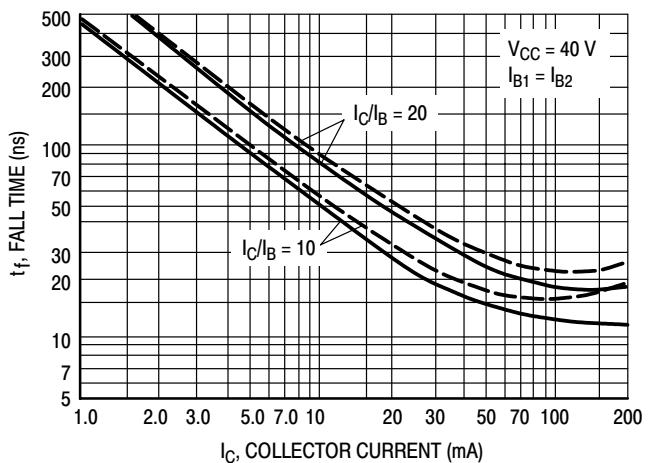
SMALL-SIGNAL CHARACTERISTICS

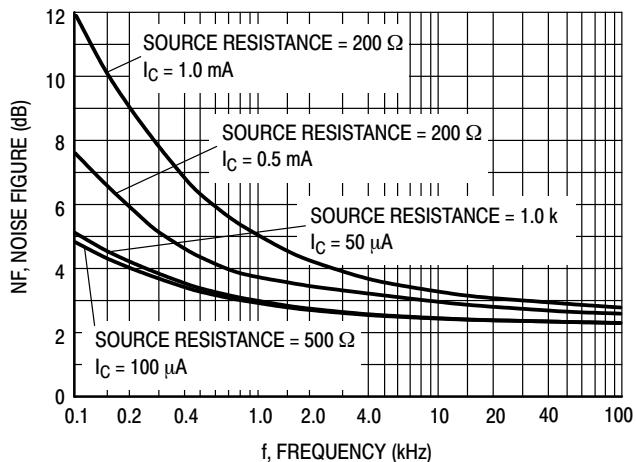
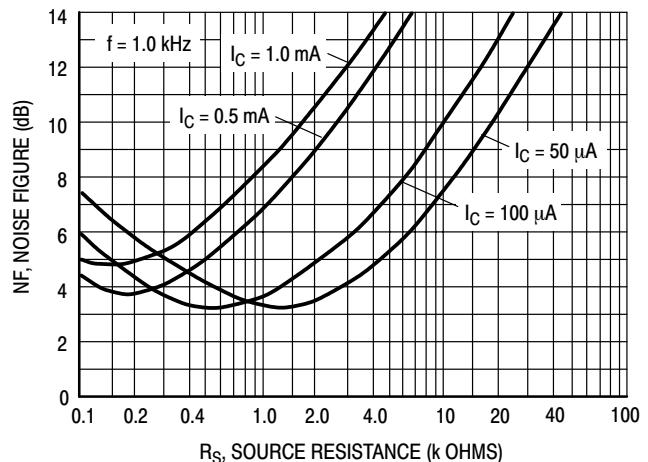
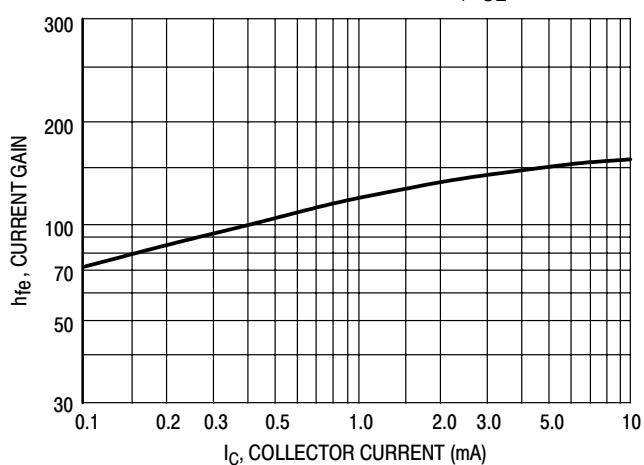
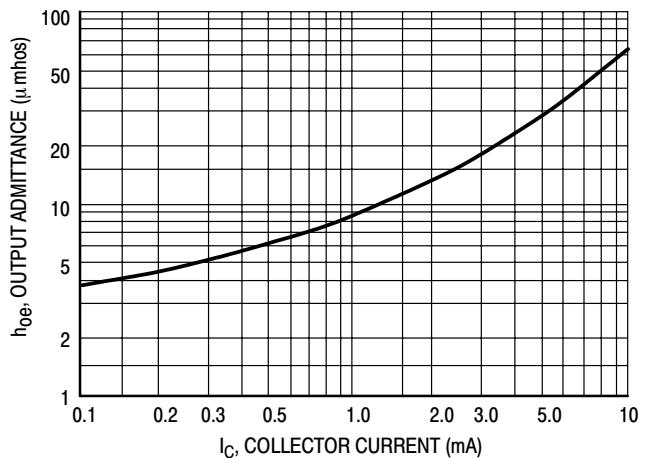
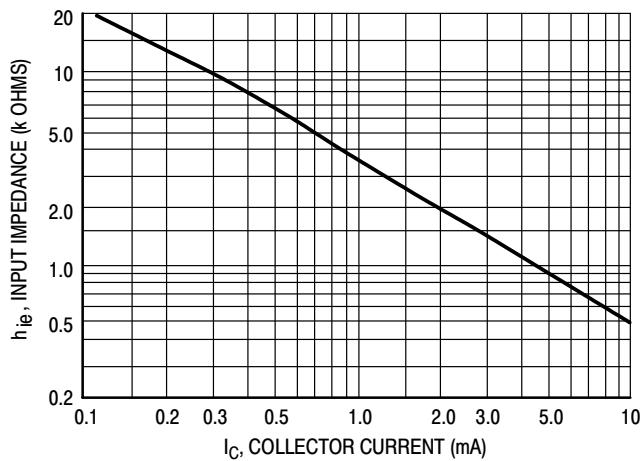
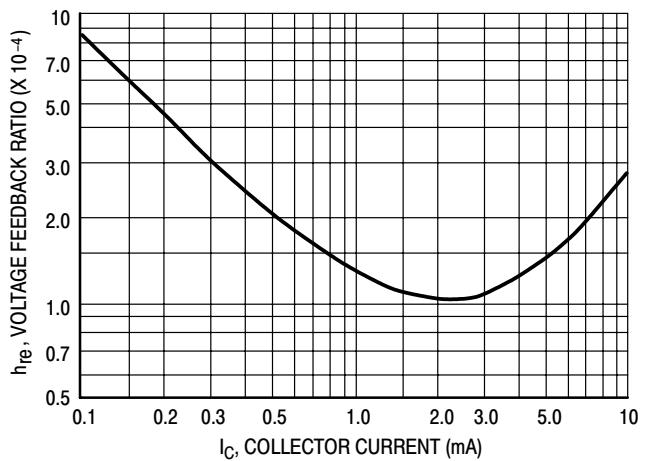
Current-Gain - Bandwidth Product (<i>I_C</i> = 10 mAdc, <i>V_{CE}</i> = 20 Vdc, <i>f</i> = 100 MHz)	<i>f_T</i>	300	—	MHz
Output Capacitance (<i>V_{CB}</i> = 5.0 Vdc, <i>I_E</i> = 0, <i>f</i> = 1.0 MHz)	C _{obo}	—	4.0	pF
Input Capacitance (<i>V_{EB}</i> = 0.5 Vdc, <i>I_C</i> = 0, <i>f</i> = 1.0 MHz)	C _{iob}	—	8.0	pF
Input Impedance (<i>I_C</i> = 1.0 mAdc, <i>V_{CE}</i> = 10 Vdc, <i>f</i> = 1.0 kHz)	<i>h_{ie}</i>	1.0	10	k Ω
Voltage Feedback Ratio (<i>I_C</i> = 1.0 mAdc, <i>V_{CE}</i> = 10 Vdc, <i>f</i> = 1.0 kHz)	<i>h_{re}</i>	0.5	8.0	X 10 ⁻⁴
Small-Signal Current Gain (<i>I_C</i> = 1.0 mAdc, <i>V_{CE}</i> = 10 Vdc, <i>f</i> = 1.0 kHz)	<i>h_{fe}</i>	100	400	—
Output Admittance (<i>I_C</i> = 1.0 mAdc, <i>V_{CE}</i> = 10 Vdc, <i>f</i> = 1.0 kHz)	<i>h_{oe}</i>	1.0	40	μ mhos
Noise Figure (<i>I_C</i> = 100 μ Adc, <i>V_{CE}</i> = 5.0 Vdc, <i>R_S</i> = 1.0 k Ω , <i>f</i> = 1.0 kHz)	NF	—	5.0	dB

SWITCHING CHARACTERISTICS

Delay Time	(<i>V_{CC}</i> = 3.0 Vdc, <i>V_{BE}</i> = 0.5 Vdc, <i>I_C</i> = 10 mAdc, <i>I_{B1}</i> = 1.0 mAdc)	t _d	—	35	ns
Rise Time		t _r	—	35	ns
Storage Time	(<i>V_{CC}</i> = 3.0 Vdc, <i>I_C</i> = 10 mAdc, <i>I_{B1}</i> = <i>I_{B2}</i> = 1.0 mAdc)	t _s	—	200	ns
Fall Time		t _f	—	50	ns

2. Pulse Test: Pulse Width \leq 300 μ s; Duty Cycle \leq 2%.

TYPICAL TRANSIENT CHARACTERISTICS
L2N3904

Figure 1. Capacitance

Figure 2. Charge Data

Figure 3. Turn-On Time

Figure 4. Rise Time

Figure 5. Storage Time

Figure 6. Fall Time

**TYPICAL AUDIO SMALL-SIGNAL CHARACTERISTICS
NOISE FIGURE VARIATIONS**
L2N3904
 $(V_{CE} = 5.0 \text{ Vdc}, T_A = 25^\circ\text{C}, \text{Bandwidth} = 1.0 \text{ Hz})$

Figure 7.

Figure 8.
 h PARAMETERS
 $(V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz}, T_A = 25^\circ\text{C})$

Figure 9. Current Gain

Figure 10. Output Admittance

Figure 11. Input Impedance

Figure 12. Voltage Feedback Ratio

TYPICAL STATIC CHARACTERISTICS

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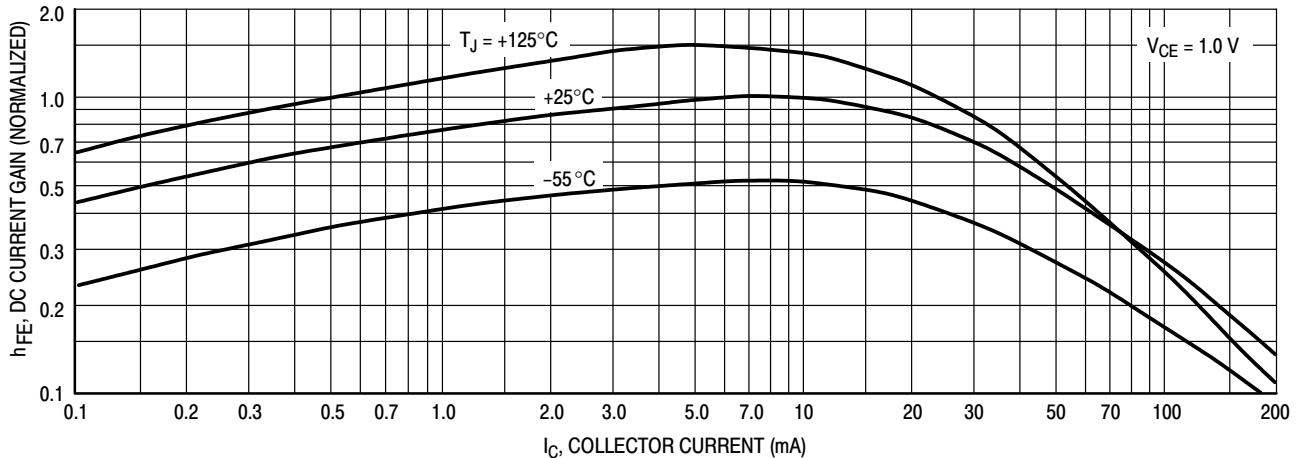


Figure 13. DC Current Gain

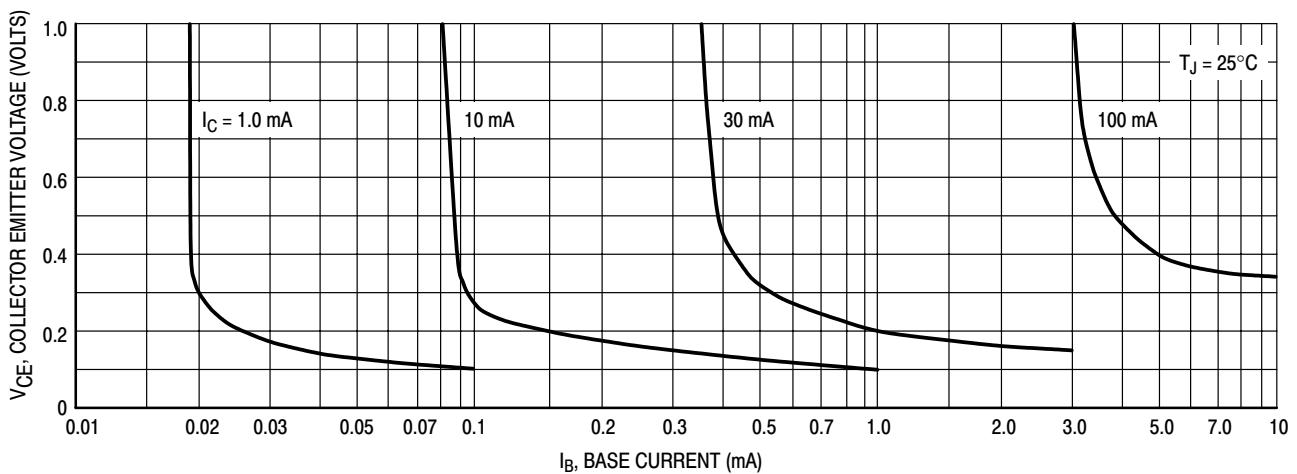


Figure 14. Collector Saturation Region

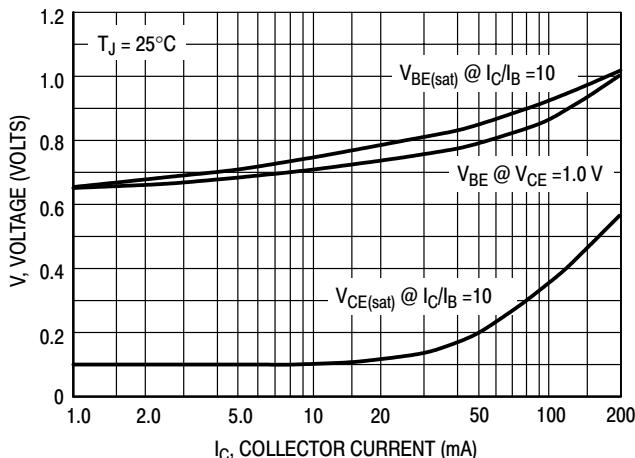


Figure 15. "ON" Voltages

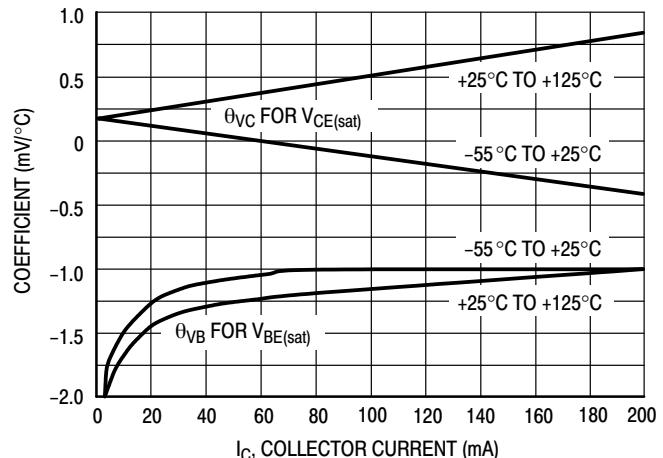
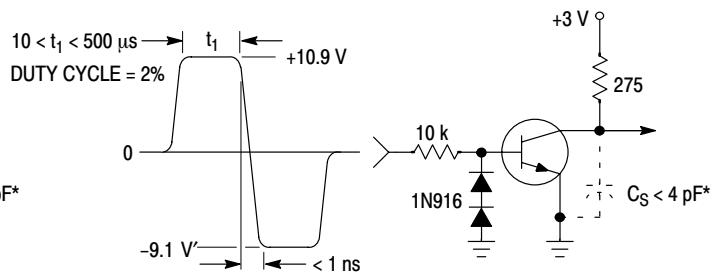
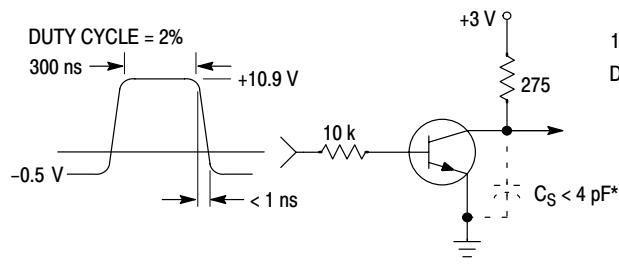


Figure 16. Temperature Coefficients

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* Total shunt capacitance of test jig and connectors

**Figure 17. Delay and Rise Time
Equivalent Test Circuit**

**Figure 18. Storage and Fall Time
Equivalent Test Circuit**